

BIH250



Start curernt	50A	
Dimensions	W52 x D47 x H29	
Weight	150g	
Housing	Plastic, Non-conductive, Non-Flammable	
Fastening	High elastic clamp	
Installation location	Busbar (Width 50mm ~ 150mm)	
Temperature probes	Contactable semiconductor type	
Frequency	2.4 GHz ISM band	
Temperature measurement	-20 ~ 200 °C	
Transmission distance	10m ~ 15m (wireless)	
Transmission cycle	4 Sec	

CIH010





Start curernt	5A	
Dimensions	W36 x D36 x H16	
Weight	35g	
Housing	Plastic, Non-conductive, Non-Flammable	
Fastening	Bandage with removable stainless steel band	
Available	Busbar Max 100mm / Cable Min. 120	
Temperature probes	Contactable semiconductor type	
Frequency	2.4 GHz ISM band	
Temperature measurement	-20 ~ 200 °C	
Transmission distance	10m ~ 15m (wireless)	
Γransmission cycle	4 Sec	

Transceiver





Nuber of Sensors Allowed	Max. 30 pcs	
Number of wireless Channels	40 Channels	
Wireless Reliability	Scheduling and Channel hopping support	
Receiving Frequency	2.4 GHz ISM band	
Receiving Distance	10m ~ 15m (Wireless)	
Temperature meansure ment method	Semiconductor Type	
Temperature meansure ment Scope	-20 ~ 200 °C	
Externel communication	RS-232 x 1 port	
	RS-422 x 1 port	
support	RS-485 (MODBUS-RTU) x 1 port	
	Ethernet (MODBUS-TCP) x 1 port	
Demession	W162.3 x D100.3 x H36	
Weight	220g	
Housing	ABS Plastic	
Fixing method	Direct Fastening (Screw)	
Power	DC 12V, 1.5A	
	1	

Under Developement

LORA Type Sensor



Housing	Plastic, Non-conductive, Non-Flammable	
Temperature probes	backside of housing with contact to busbar	
Temperature measurement	-20°C~200°C	
Transmission distance	100m ~ 200m (wireless)	
Transmit frequency	2.4GHz ISM band	
Transmission cycle	4 Sec	
Communication method	Star or Mash Type	

LTE Transceiver





Allowed Sensors	Max. 30 pcs	
Wireless Channels	40 Channels	
Wireless Reliability	Scheduling and Channel hopping support	
Receiving Frequency	2.4 GHz ISM band, LTE	
Externel communication support	RS-485(MODBUS-TCP) x 1Port	
Transmission distance	LTE possible range	
Option	Mobile App	



01



Self-Generation – Energy harvesting for semi-permanert use without additional power

02



Securing insulation safety through wireless 2.4GHZ communication technology

03



Reliable temperature measurement with contact—type semiconductor temperature sendor

04



System can be implemented without new construct for existing electric equipment

05



Technology applied on circuit composition to avoid electromagnatic interference in high voltage equipment

06



Predicting and replacement timing of electric equipment by digital temperature—data

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Prevention of electric shocks with real-time temperature monitoring

U8



Temperature measurement blind spot of electric equipment without opening the door

09



Support for on-site customized product development applying original technology

10



Rapid A/S response with original technology

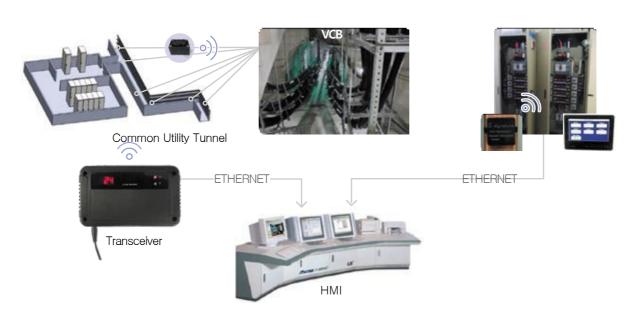


Electric Facility



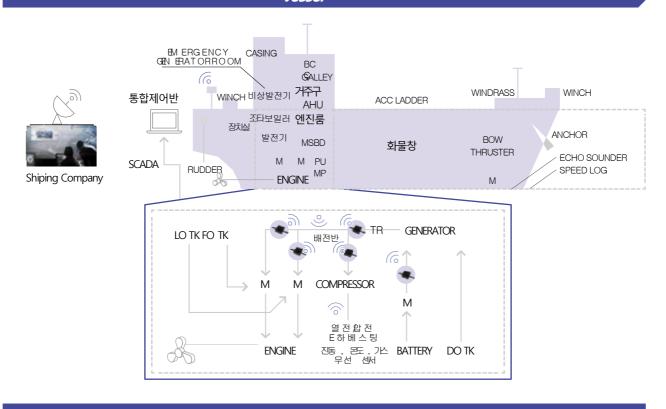
Low Voltage Panel

Common Utility Tunnel

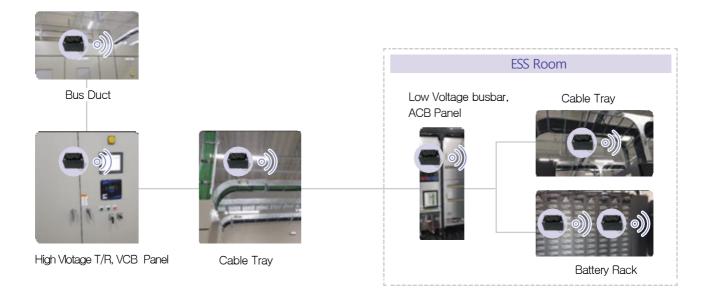




Vessel



ESS Room



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Power Facility



KEPCO Jinju Trasforming Station 154 KV T/R Bushing, Lead-in Busbar, Unmanned Transforming Station Power line



KEPCO Youngheung Thermal Power Plant 6.6KV High Voltage Pannel

Telecom



KT Kangnam IDC, KT Yeouido IDC Low Voltage Panel



Ship Building



HHI - Ulsan Plating Plant MCCB



Pukyong National University "Baik-Kyung-Ho" MSBD

Water Supplyer



Kwater Ducsan Purefication MOLD TR Panel

PERFORMANCE

Production Facility







LS Cable & System Donghai Plant Busduct







Hyundai Steel 154 KV Main VCB Panel, 33000V ACB Panel

Others

Client	Reference	
Kwangmyung Electric	Smart Switch Gear	
Hyundai Electric	Sun-am Plant Factory	SK Hynix, KCC
Samsung Display	Test Bed	Al Box
POSCO	Po-hang Research Institute	

